



Date issued : March 31, 2020

### Bulletin

We, CHI MEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

<b>POLYLAC® ABS (J01)</b>	PA-704LRP, PA-705, PA-707, PA-757, PA-757F, PA-757N, PA-717C, PA-726, PA-726M, PA-727, PA-747, PA-709, PA-797, PA-756, PA-756S, PA-756H, PA-716, PA-746, PA-746H, PA-737, PA-747H, PA-747R, PA-747F, PA-747S, PA-709S, PA-709P, PA-709K, PA-709H, PA-797S, PA-777B, PA-777C, PA-777D, PA-777E, PA-757K, PA-757GJ08, PA-718, PA-746Y, PA-757 A01, PA-747S A01, PA-749, PA-749S, PA-757H, PA-737 A03, PA-77NB, PA-797, PA-746M
	(J01) - The suffix may be used to denote the black color grade manufactured from Chi Mei Corp.
	(A01 & A03) - The suffix may be used to denote the white color grade manufactured from Chi Mei Corp.
<b>POLYLAC® MABS</b>	PA-703TRP, PA-758, PA-758R, LS-L230
<b>KIBISAN® SAN</b>	PN-106, PN-107, PN-117, PN-117C, PN-117H, PN-127, PN-127H, PN-137H, PN-106 L150 FG, PN-107 L125 FG, PN-117 L200 FG, PN-127 L150 FG
<b>POLYREX® PS</b>	PG-22, PG-33, PG-80N, PG-80, PG-383, PG-383D, PH-55Y, PH-60, PH-88, PH-888H, PH-888G, PH-88S, PH-88SF
<b>ACRYREX® PMMA</b>	CM-203, CM-205, CM-205G, CM-205N, CM-207, CM-207G, CM-211, CM-211G
<b>ACRYSTEX® SMMA</b>	PM-600, PM-500, PM-500G, PM-700G
<b>KIBITON® TPE</b>	PB-575, PB-585, PB-587, PB-511, PB-5300, PB-5301, PB-5302, PB-5308, PB-5502
<b>KIBITON® Q-resin</b>	PB-5903, PB-5910, PB-5925, PB-5900, PB-5630, PB-5906
<b>KIBIPOL® LBR/SSBR/HBR</b>	PR-245, PR-255, PR-1205, PR-040, PR-040S, PR-040G, PR-040C, PR-050, PR-060S, PR-303
<b>ACRYPOLY®</b>	CM-205X, CM-205B, LM-700X, PM-500X
<b>KIBILITE®</b>	DC-553F, DC-603F, DS-553A, DS-603A, DS-743B, DM-553B, DC-552F, DC-552G, DS-653A, DS-553C, DS-603C, DS-653C, DS-753B, DM-000B, DS-903A, DS-943A, DS-943B, DS-903E, DS-963E, DS-943G, DS-963G, DS-903H, DS-943H, DS-943I, DS-553H, DM-601M, DM-601R, DM-551M, DS-601S, DS-601Y, DS-551A
<b>KIBILAC®</b>	PW-957, PW-978B, PW-997S, PW-997, PW-997G

contain no following substances.

- |   |  |
|---|--|
| 1. Halogen (F, Br, I) and its compounds     | 33. REACH- Candidate List of SVHC  |
| 2. Halogen (Cl)                             | 34. Radioactive Substances   |
| 3. PBDEs (Polybrominated Diphenyl Ethers)   | 35. Natural Latex  |
| 4. PBBs (Polybrominated Biphenyls)          | 36. Dioxins and furans   |
| 5. Ozone Depleting Chemicals (CFCs & HCFCs) | 37. Primary aromatic amines (PAA)  |
| 6. Chlorinated Paraffin (C10-C13)           | 38. Perchlorate  |
| 7. Polyvinyl Chloride (PVC)                 | 39. Hexachlorobenzene  |
| 8. Mercury (Hg) and its compounds           | 40. Mirex  |
| 9. Lead (Pb) and its compounds              | 41. Specified amine compounds  |
| 10. Cadmium (Cd) and its compounds          | 42. Benzene  |
| 11. Chromium (Cr) and its compounds         | 43. Benzenamine, N-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST) |
| 12. Arsenic (As) and its compounds          | 44. Polyamide  |
| 13. Antimony (Sb) and its compounds         |  |

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHI MEI CORPORATION at the date of issue. CHI MEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHI MEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHI MEI CORPORATION. In no event will CHI MEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.



- |   |  |
|---|--|
| 14. Selenium (Se) and its compounds   | 45. PVDC (polyvinylidene chloride)                         |
| 15. Barium (Ba) and its compounds   | 46. ESBO (Expoxidized soybean oil)                         |
| 16. Beryllium (Be) and its compounds  | 47. Formamide  |
| 17. Bismuth (Bi) and its compounds  | 48. Hexabromocyclododecane (HBCDD)                         |
| 18. Organic tin compounds (TBT, TPT, DOT, DBT)  | 49. Red phosphorus   |
| 19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs)   | 50. Aniline · formaldehyde polycondensate                  |
| 20. Poly naphthalenes   | 51. Fluorescent powder                                     |
| 21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)  | 52. 4,4'-Sulfonyldiphenol (BPS)                            |
| 22. Asbestos  | 53. Tris(1-chloro-2-propyl)phosphate (TCPP)                |
| 23. Phthalates  | 54. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP)           |
| 24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE) | 55. Tris (2,3-dibromopropyl) phosphate                     |
| 25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole   | 56. Tris (aziridiny) phosphin oxide                        |
| 26. PFOA and its compounds  | 57. Tri-o-cresyl phosphate                                 |
| 27. PFOS and its compounds  | 58. Tris (2-chloroethyl) phosphate (TCEP)                  |
| 28. Bisphenol A   | 59. Perfluorohexane-1-sulphonic acid and its salts (PFHxS) |
| 29. Formaldehyde  | 60. Diisononyl phthalate (DINP)                            |
| 30. Dimethylfumarate (DMF)  | 61. Di-isodecyl phthalate (DIDP)                           |
| 31. Triclosan   | 62. Di-n-octyl phthalate (DnOP)                            |
| 32. Nickel  | 63. Diethyl phthalate (DEP)                                |
|   | 64. Dimethyl phthalate (DMP)                               |
|   | 65. Cobalt   |
|   | 66. Mica   |
|   | 67. Graphite   |

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (2011/65/EU), 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,

  
Perry D. B. Shiueh

Vice President of R&D Division

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHI MEI CORPORATION at the date of issue. CHI MEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHI MEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHI MEI CORPORATION. In no event will CHI MEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.